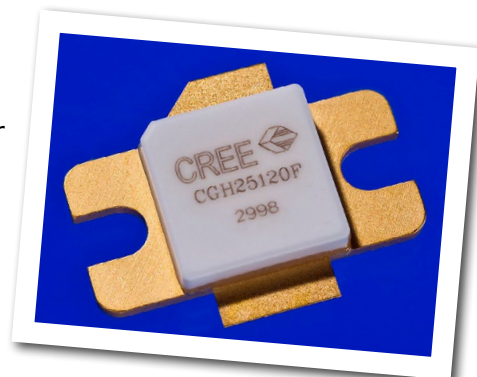


CGH25120F

120 W, 2300-2700 MHz, GaN HEMT for WiMAX and LTE

Cree's CGH25120F is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGH25120F ideal for 2.3-2.7GHz WiMAX, LTE and BWA amplifier applications. The transistor is supplied in a ceramic/metal flange package.



Package Type: 440162
PN: CGH25120F

Typical Performance Over 2.3-2.7GHz ($T_c = 25^\circ\text{C}$) of Demonstration Amplifier

Parameter	2.3 GHz	2.4 GHz	2.5 GHz	2.6 GHz	2.7 GHz	Units
Gain @ 43 dBm	12.5	12.8	13.1	13.5	13.6	dB
ACLR @ 43 dBm	-32.7	-34.0	-32.5	-29.5	-25.8	dBc
Drain Efficiency @ 43 dBm	26.5	28.0	30.0	32.5	34.5	%

Note:

Measured in the CGH25120F-TB amplifier circuit, under equivalent 802.16e WiMAX signal, 10 MHz Bandwidth, PAR = 9.6 dB @ 0.01 % Probability on CCDF.

Features

- 2.3 - 2.7 GHz Operation
- 13 dB Gain
- -32 dBc ACLR at 20 W P_{AVE}
- 30 % Efficiency at 20 W P_{AVE}
- High Degree of DPD Correction Can be Applied





Absolute Maximum Ratings (not simultaneous) at 25 °C Case Temperature

Parameter	Symbol	Rating	Units	Units
Drain-Source Voltage	V_{DS}	84	Volts	25 °C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25 °C
Power Dissipation	P_{DISS}	56	Watts	
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225	°C	
Maximum Forward Gate Current	I_{GMAX}	30	mA	25 °C
Maximum Drain Current ¹	I_{DMAX}	12	A	25 °C
Soldering Temperature ²	T_S	245	°C	
Screw Torque	τ	80	in-oz	
Thermal Resistance, Junction to Case ³	R_{JC}	1.5	°C/W	85 °C
Case Operating Temperature ³	T_C	-40, +150	°C	

Note:

¹ Current limit for long term, reliable operation.

² Refer to the Application Note on soldering at www.cree.com/products/wireless_apnotes.asp

³ Measured for the CGH25120F at $P_{DISS} = 56$ W.

Electrical Characteristics ($T_C = 25^\circ\text{C}$)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10$ V, $I_D = 28.8$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V_{DC}	$V_{DS} = 28$ V, $I_D = 0.5$ A
Saturated Drain Current ²	I_{DS}	23.2	28.0	-	A	$V_{DS} = 6.0$ V, $V_{GS} = 2.0$ V
Drain-Source Breakdown Voltage	V_{BR}	120	-	-	V_{DC}	$V_{GS} = -8$ V, $I_D = 28.8$ mA
RF Characteristics ($T_C = 25^\circ\text{C}$, $F_0 = 2.5$ GHz unless otherwise noted)						
Saturated Output Power ^{3,4,5}	P_{SAT}	-	130	-	W	$V_{DD} = 28$ V, $I_{DQ} = 0.5$ A,
Pulsed Drain Efficiency ^{3,5}	η	-	60	-	%	$V_{DD} = 28$ V, $I_{DQ} = 0.5$ A, $P_{OUT} = P_{SAT}$
Gain ⁶	G	10.5	12.5	-	dB	$V_{DD} = 28$ V, $I_{DQ} = 0.5$ A, $P_{OUT} = 43$ dBm
WiMAX Linearity ^{6,7}	ACLR	-	-31	-27	dBc	$V_{DD} = 28$ V, $I_{DQ} = 0.5$ A, $P_{OUT} = 43$ dBm
Drain Efficiency ⁶	η	27	32	-	%	$V_{DD} = 28$ V, $I_{DQ} = 0.5$ A, $P_{OUT} = 43$ dBm
Output Mismatch Stress	VSWR	-	-	10 : 1	Ψ	No damage at all phase angles, $V_{DD} = 28$ V, $I_{DQ} = 1.0$ A, $P_{OUT} = 20$ W CW
Dynamic Characteristics						
Input Capacitance ⁸	C_{GS}	-	88	-	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Output Capacitance ⁸	C_{DS}	-	12	-	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Feedback Capacitance	C_{GD}	-	1.6	-	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz

Notes:

¹ Measured on wafer prior to packaging.

² Scaled from PCM data.

³ Pulse Width = 40 μ S, Duty Cycle = 5 %.

⁴ P_{SAT} is defined as $I_G = 10$ mA peak.

⁵ Measured in CGH25120F-TB.

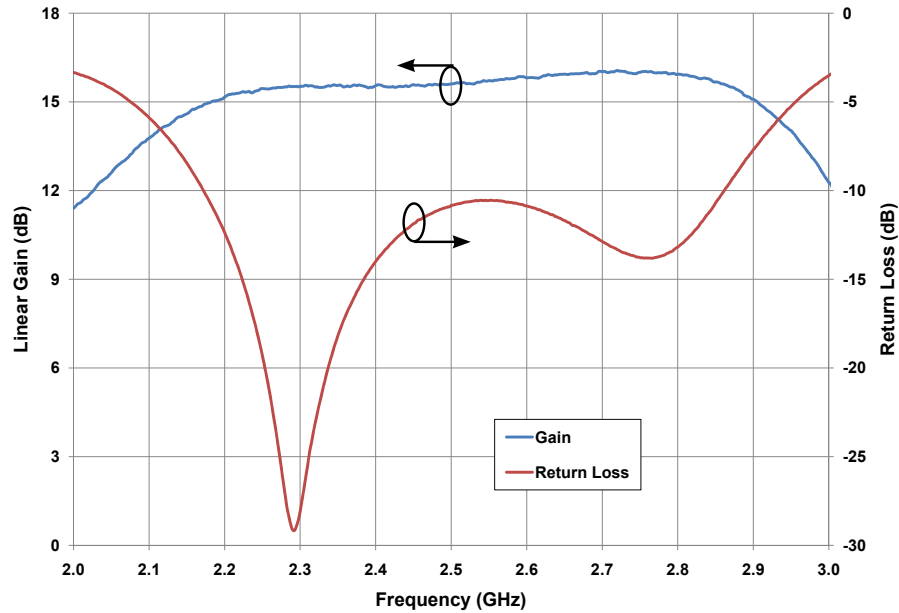
⁶ Equivalent 802.16e WiMAX signal, 10 MHz Bandwidth, PAR = 9.6 dB @ 0.01% Probability on CCDF.

⁷ Measured over 10 MHz bandwidth at 10 MHz offset from carrier edge.

⁸ Includes package and internal matching components.

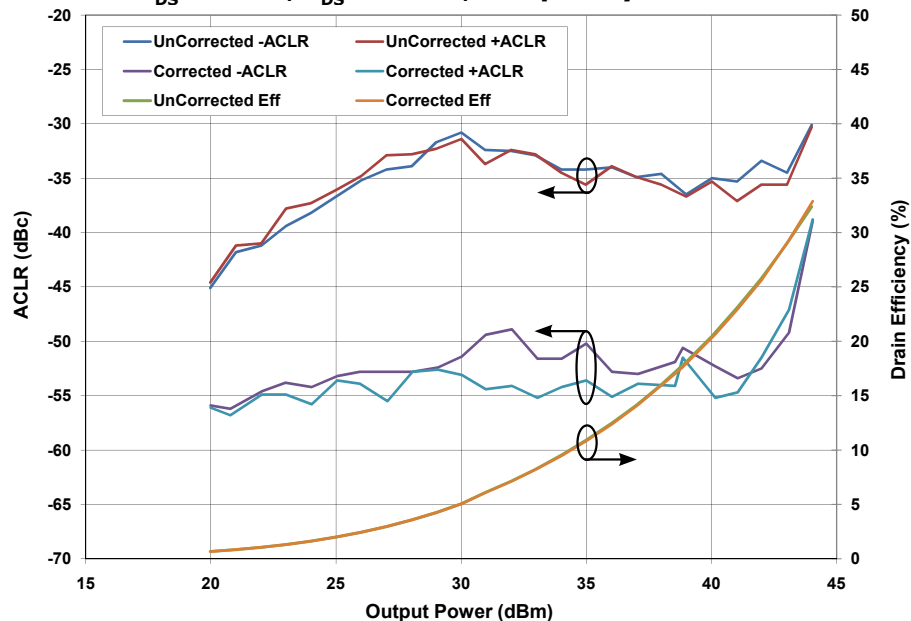
Typical Performance

Gain and Input Return Loss vs Frequency of CGH25120F in Broadband Amplifier Circuit
 $V_{DD} = 28 \text{ V}$, $I_{DQ} = 0.5 \text{ A}$



Typical Mobile WiMAX Digital Pre-Distortion (DPD) Performance

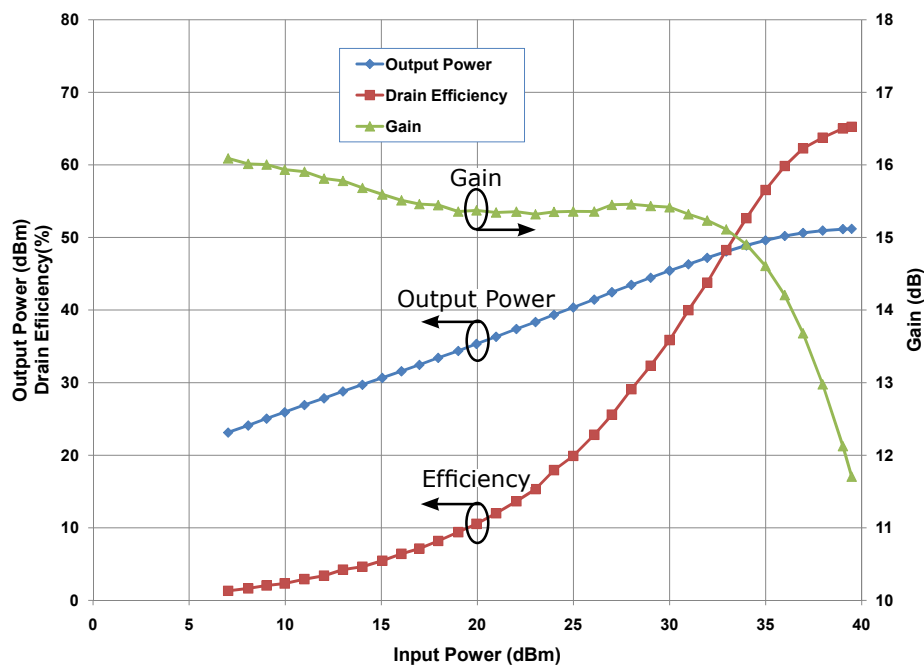
WiMAX Characteristics with and without DPD Correction
ACLR and Drain Efficiency vs Output Power
of the CGH25120F measured in CGH25120F-TB Amplifier Circuit.
 $V_{DS} = 28 \text{ V}$, $I_{DS} = 0.5 \text{ A}$, Frequency = 2.5 GHz



Typical Pulse Performance

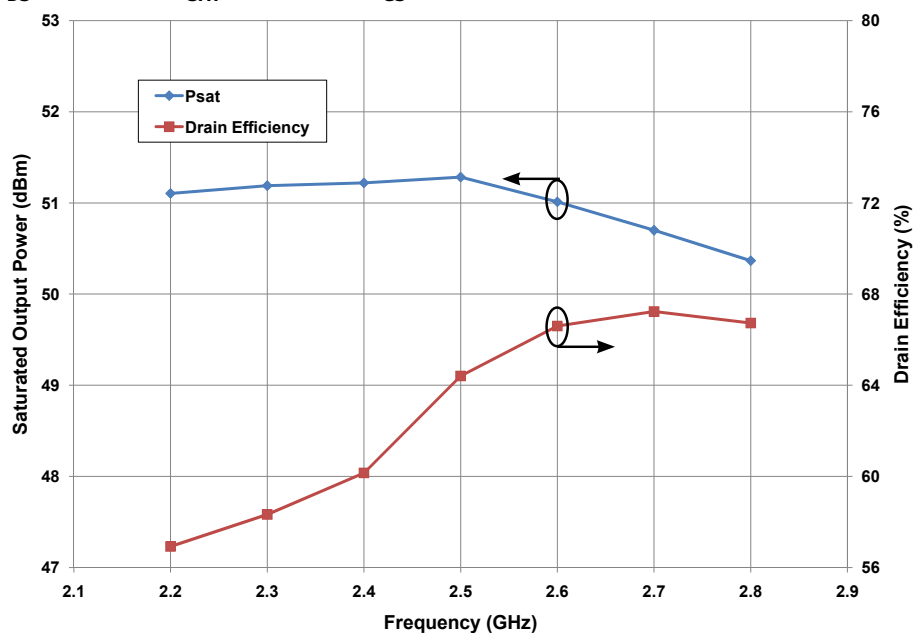
Typical Pulse Characteristics Output Power, Drain Efficiency, and Gain vs Input Power of the CGH25120F measured in CGH25120F-TB Amplifier Circuit.

$V_{DS} = 28\text{ V}$, $I_{DS} = 0.5\text{ A}$, Freq = 2.5 GHz, Pulse Width = 40 μS , Duty Cycle = 5 %



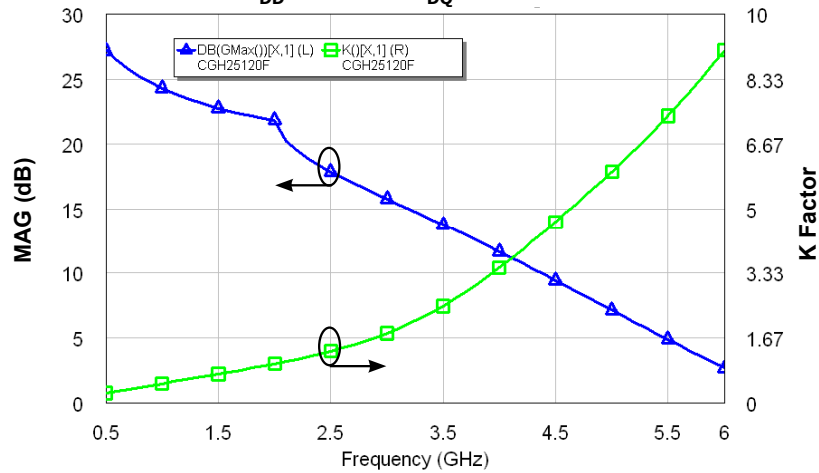
Typical Pulsed Saturated Power vs Frequency of the CGH25120F measured in CGH25120F-TB Amplifier Circuit.

$V_{DS} = 28\text{ V}$, $I_{DS} = 0.5\text{ A}$, $P_{SAT} = 10\text{ mA}$ I_{GS} Peak, Pulse Width = 40 μS , Duty Cycle = 5 %



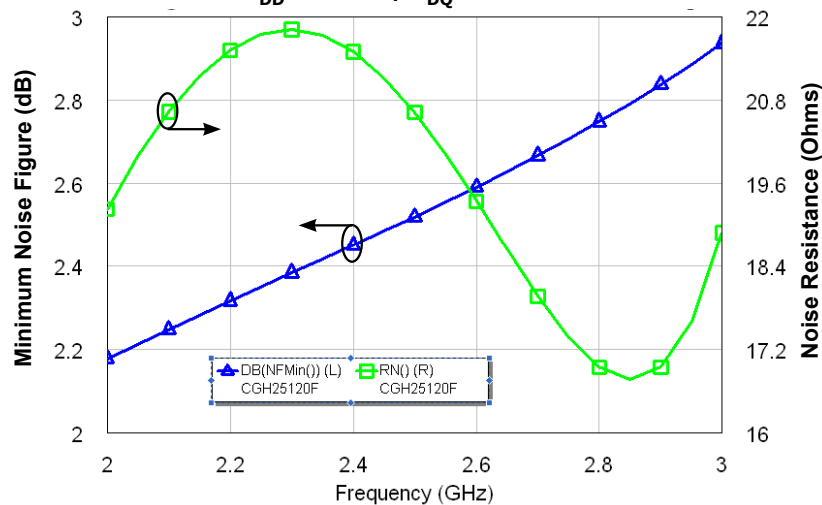
Typical Performance

Simulated Maximum Available Gain and K Factor of the CGH25120F
 $V_{DD} = 28 \text{ V}$, $I_{DQ} = 500 \text{ mA}$



Typical Noise Performance

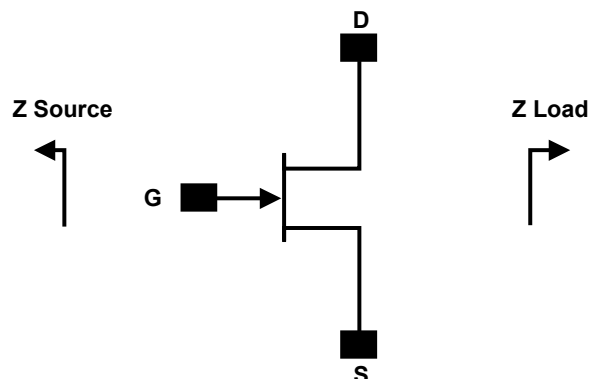
Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH25120F
 $V_{DD} = 28 \text{ V}$, $I_{DQ} = 500 \text{ mA}$



Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

Source and Load Impedances

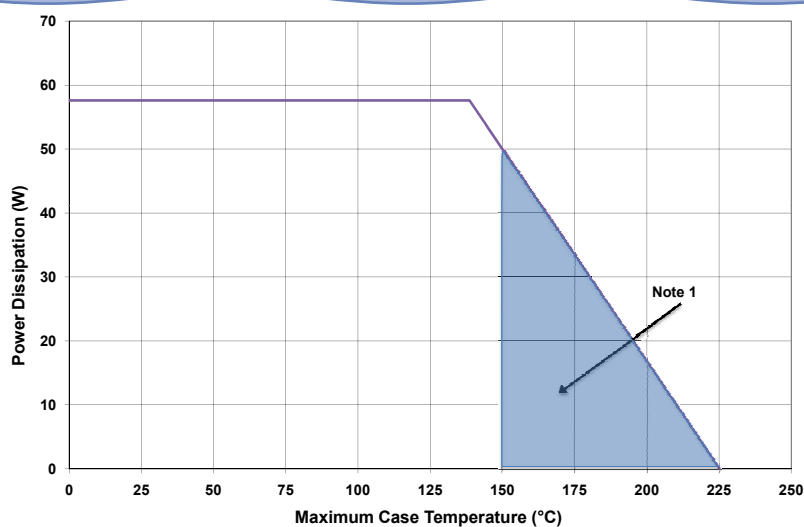


Frequency (MHz)	Z Source	Z Load
2300	6.80 - j12.19	4.38 - j1.42
2350	6.42 - j11.89	4.39 - j1.36
2400	6.05 - j11.61	4.39 - j1.33
2450	5.71 - j11.34	4.36 - j1.32
2500	5.37 - j11.08	4.31 - j1.33
2550	5.04 - j10.83	4.23 - j1.34
2600	4.71 - j10.57	4.11 - j1.36
2650	4.39 - j10.31	3.98 - j1.37
2700	4.07 - j10.04	3.80 - j1.36

Note¹: $V_{DD} = 28V$, $I_{DQ} = 500mA$. In the 440162 package.

Note²: Impedances are extracted from CGH25120F-TB demonstration circuit and are not source and load pull data derived from transistor.

CGH25120F Power Dissipation De-rating Curve

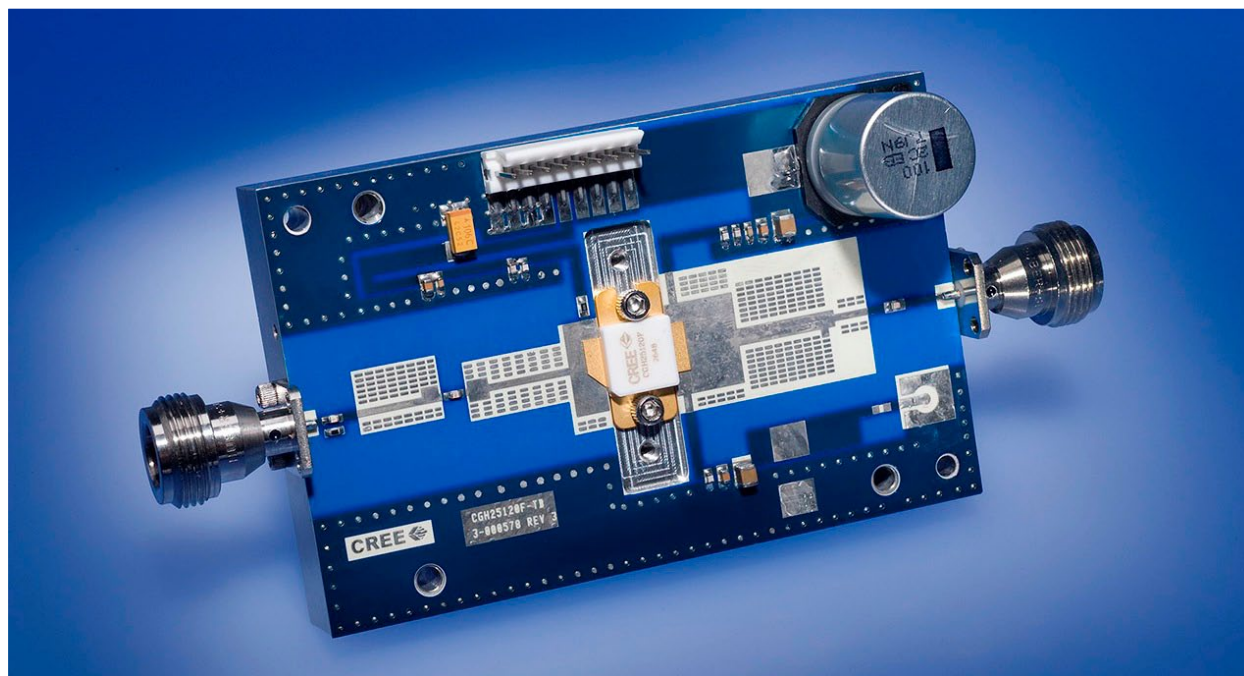


Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

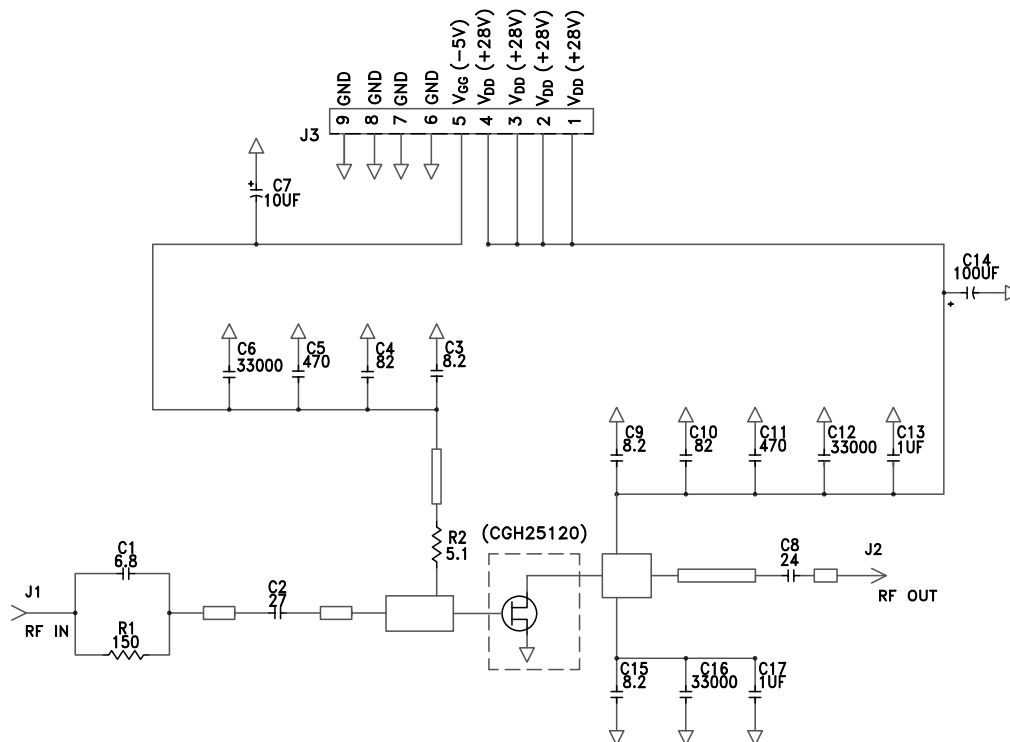
CGH25120F-TB Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 1/16 W, 0603, 1%, 150 OHMS	1
R2	RES, 1/16 W, 0603, 1%, 5.1 OHMS	1
C1	CAP, 6.8 pF, +/-0.25 pF, 0603, ATC600S	1
C2	CAP, 27 pF, +/-5%, 0603, ATC600S	1
C3,C9,C15	CAP, 8.2 pF, +/-0.25 pF, 0603, ATC600S	3
C4,C10	CAP, 82.0 pF, +/-5%, 0603, ATC600S	2
C5,C11	CAP, 470 pF, 5%, 100V, 0603, X7R	2
C6,C12,C16	CAP, 33000 pF, 0805, 100V, X7R	3
C7	CAP, 10 UF, 16V, TANTALUM	1
C8	CAP, 24 pF, +/-5%, 0603, ATC600S	1
C13,C17	CAP, 1.0 UF, 100V, 10%, X7R, 1210	2
C14	CAP, 100 UF, +/-20%, 160V, ELECTROLYTIC	1
J1,J2	CONN, N-Type, Female, 0.500 SMA Flange	2
J3	CONN, Header, RT> PLZ, 0.1 CEN, LK, 9 POS	1
-	PCB, RO4350, Er = 3.48, h = 20 mil	1
-	CGH25120F	1

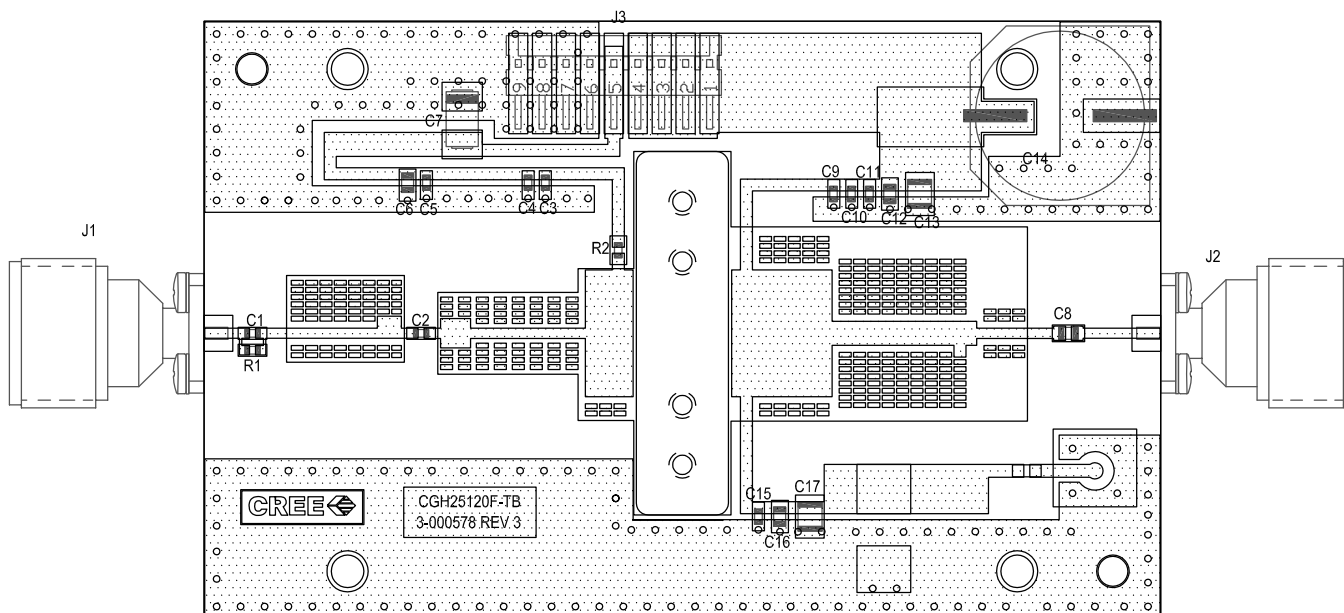
CGH25120F-TB Demonstration Amplifier Circuit



CGH25120F-TB Demonstration Amplifier Circuit Schematic



CGH25120F-TB Demonstration Amplifier Circuit Outline





Typical Package S-Parameters for CGH25120 (Small Signal, $V_{DS} = 28\text{ V}$, $I_{DQ} = 500\text{ mA}$, angle in degrees)

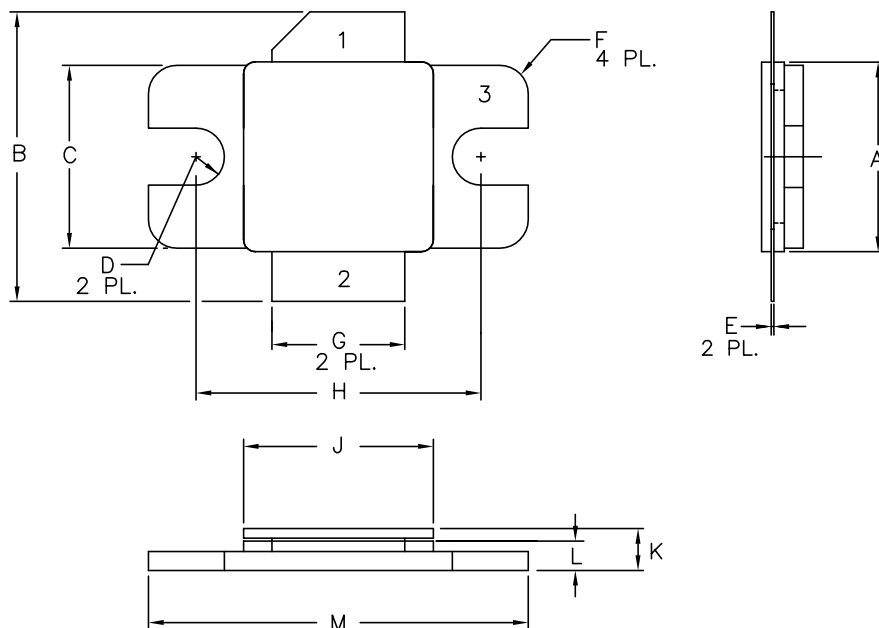
Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.970	179.55	3.23	65.19	0.006	-19.55	0.697	-171.85
600 MHz	0.969	178.04	2.71	59.73	0.006	-23.92	0.712	-171.11
700 MHz	0.969	176.68	2.35	54.43	0.006	-28.13	0.728	-170.54
800 MHz	0.968	175.39	2.08	49.24	0.006	-32.20	0.744	-170.15
900 MHz	0.967	174.12	1.88	44.13	0.006	-36.17	0.760	-169.90
1.0 GHz	0.965	172.86	1.73	39.07	0.006	-40.07	0.776	-169.80
1.1 GHz	0.963	171.57	1.62	34.02	0.007	-43.93	0.792	-169.82
1.2 GHz	0.961	170.24	1.53	28.94	0.007	-47.79	0.808	-169.93
1.3 GHz	0.957	168.86	1.47	23.78	0.007	-51.71	0.823	-170.13
1.4 GHz	0.953	167.39	1.43	18.47	0.007	-55.72	0.838	-170.41
1.5 GHz	0.948	165.84	1.41	12.95	0.007	-59.92	0.853	-170.74
1.6 GHz	0.941	164.19	1.40	7.11	0.008	-64.38	0.868	-171.14
1.7 GHz	0.932	162.42	1.41	0.85	0.008	-69.21	0.882	-171.61
1.8 GHz	0.921	160.54	1.44	-5.98	0.009	-74.56	0.897	-172.16
1.9 GHz	0.906	158.55	1.49	-13.54	0.009	-80.57	0.912	-172.82
2.0 GHz	0.887	156.51	1.54	-22.02	0.010	-87.43	0.928	-173.62
2.1 GHz	0.863	154.51	1.61	-31.62	0.011	-95.34	0.943	-174.61
2.2 GHz	0.836	152.72	1.68	-42.48	0.012	-104.43	0.956	-175.83
2.3 GHz	0.807	151.32	1.73	-54.61	0.012	-114.71	0.966	-177.27
2.4 GHz	0.782	150.41	1.76	-67.78	0.013	-125.92	0.970	-178.85
2.5 GHz	0.767	149.70	1.74	-81.50	0.013	-137.58	0.968	-179.58
2.6 GHz	0.765	148.57	1.69	-95.15	0.013	-149.05	0.960	-178.22
2.7 GHz	0.772	146.34	1.61	-108.22	0.012	-159.82	0.948	-177.17
2.8 GHz	0.784	142.57	1.52	-120.49	0.012	-169.67	0.937	-176.41
2.9 GHz	0.795	137.00	1.43	-132.07	0.012	-178.68	0.926	-175.88
3.0 GHz	0.802	129.35	1.37	-143.26	0.011	-172.84	0.918	-175.48
3.2 GHz	0.800	105.38	1.29	-166.46	0.011	-155.52	0.907	-174.80
3.4 GHz	0.786	62.35	1.25	-164.88	0.011	-133.38	0.901	-174.02
3.6 GHz	0.824	-2.68	1.08	-128.15	0.010	-103.76	0.897	-172.96
3.8 GHz	0.913	-61.31	0.73	-93.46	0.007	-76.68	0.890	-171.72
4.0 GHz	0.963	-96.70	0.45	-69.63	0.005	-60.78	0.881	-170.41
4.2 GHz	0.983	-116.99	0.29	-53.87	0.003	-53.02	0.872	-168.93
4.4 GHz	0.992	-129.53	0.19	-42.45	0.002	-49.41	0.860	-167.19
4.6 GHz	0.995	-137.94	0.14	-33.27	0.002	-47.62	0.844	-165.11
4.8 GHz	0.997	-143.97	0.10	-25.19	0.002	-46.36	0.823	-162.61
5.0 GHz	0.998	-148.50	0.08	-17.50	0.001	-44.82	0.793	-159.54
5.2 GHz	0.999	-152.04	0.07	-9.61	0.001	-42.41	0.751	-155.74
5.4 GHz	0.999	-154.90	0.06	-0.93	0.001	-38.57	0.688	-150.96
5.6 GHz	0.999	-157.26	0.05	-9.20	0.001	-32.67	0.594	-145.02
5.8 GHz	0.999	-159.26	0.04	-21.62	0.001	-23.98	0.453	-138.33
6.0 GHz	1.000	-160.97	0.04	-36.99	0.001	-11.87	0.251	-136.18

Download this s-parameter file in ".s2p" format at http://www.cree.com/products/wireless_s-parameters.asp

Product Dimensions CGH25120F (Package Type — 440162)

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.395	.405	10.03	10.29
B	.580	.620	14.73	15.75
C	.380	.390	9.65	9.91
D	.055	.065	1.40	1.65
E	.004	.006	0.10	0.15
F	.055	.065	1.40	1.65
G	.275	.285	6.99	7.24
H	.595	.605	15.11	15.37
J	.395	.405	10.03	10.29
K	.129	.149	3.28	3.78
L	.053	.067	1.35	1.70
M	.795	.805	20.19	20.45

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE



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